



GE Energy

Functional Testing Specification

Parts & Repair Services
Louisville, KY

LOU-GED-148D2635G1

Test Procedure for a 148D2635G1 board

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DATE 10/20/2011	DATE	DATE	DATE 10/20/2011

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1. SCOPE

1.1 This is a functional testing procedure for a 148D2635G1 printed circuit board.

2. STANDARDS OF QUALITY

2.1 Refer to the current revision of the IPC-A-610 standard for workmanship standards.

3. APPLICABLE DOCUMENTS

3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.

3.1.1 Check board's electronic folder for more information

4. ENGINEERING REQUIREMENTS

4.1 Equipment Cleaning

4.1.1 Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.

4.2 Equipment Inspection

4.2.1 Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:

4.2.1.1 Wires - broken, cracked, or loosely connected

4.2.1.2 Terminal strips / connectors - broken or cracked

4.2.1.3 Components - visually damaged

4.2.1.4 Capacitors - bloated or leaking

4.2.1.5 Solder joints - damaged or cold

4.2.1.6 Circuit board - burned or de-laminated

4.2.1.7 Printed wire runs / Traces - burned or damaged

5. EQUIPMENT REQUIRED

5.1 The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
2		30VDC Power Supplies
1		Fluke 85 or equivalent

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6. Modifications/Upgrades

6.1 Check Orange Book for any modifications or upgrades.

7. Testing Process

7.1 Testing Procedure

7.1.1 Apply +30VDC to pin-17, Common to Pin-19, and -22VDC to Pin-21.

7.1.2 TP6 should read +12.7VDC +-10%.

7.1.3 TP7 should read -12.7VDC +-10%.

7.1.4 TP5 should adjust from 0VDC to +7VDC with R5, (R6 must be fully CCW), set TP5 for +3.0VDC

7.1.5 TP2 should adjust from 0VDC to +20VDC with R2, set TP2 for +10VDC.

7.1.6 Connect TP1 to Common. The voltage at Pin-12 should adjust from -0.4VDC to -3.6VDC with R3.

7.1.7 Turn power supplies off.

7.1.8 Make the following resistance checks;

7.1.8.1 Remove all other connections and voltages.

7.1.8.2 Pin-20 to Pin-36 = 20K +-5% ohms.

7.1.8.3 Pin 3 to Pin-20 = 100K ohms (R1 fully CCW)

7.1.8.4 Pin 3 to Pin-20 = 1.1M ohms (R1 fully CCW)

7.2 ***TEST COMPLETE ***

7.3 Post Testing Burn-in Required ☒ Yes ☐ No



Note: All Turbine cards should be subjected to a 100 hour power soak.

8. Notes

8.1 None at this time.

9. Attachments

9.1 None at this time.